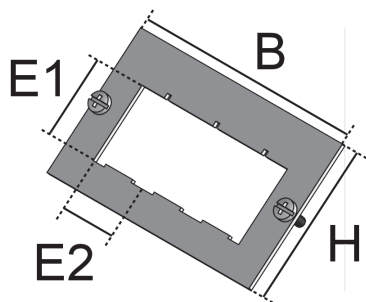


UDEP COR

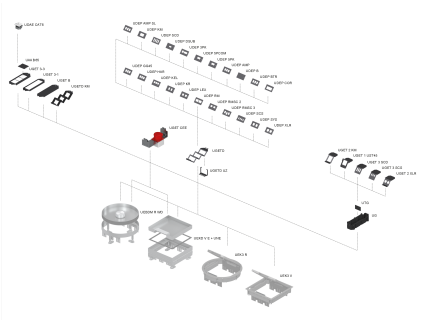
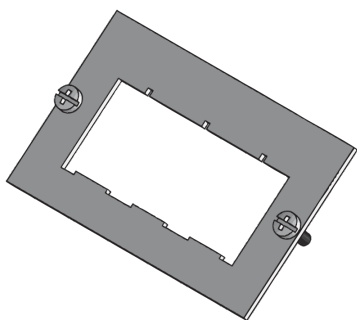
Mounting board, data technology



UDEP COR components are installation boards from the underfloor system range. The boards are bolted into data device carriers and are used to accommodate a maximum of 3 LANscape data jacks made by Corning. The installation boards are made of aluminium with a black coating on one side and have the installation dimensions of E1 22.8 mm and E2 18 mm.

Artikel	Typ	H	B	data jacks	E1	E2	colour	W
UDEP-COR 3	adapter board,	46 mm	75 mm	3	22.8 mm	18 mm	black	0.010 kg

DETAIL- UND ANWENDUNGSBILDER



OPTIONALES ZUBEHÖR

UGETD

